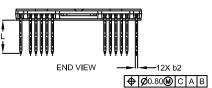


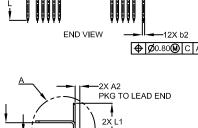


e3

AHPM15-CDE AUTOMOTIVE MODULE CASE MODHT ISSUE O

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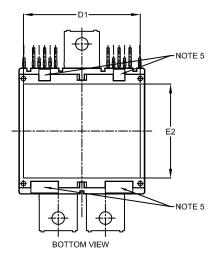


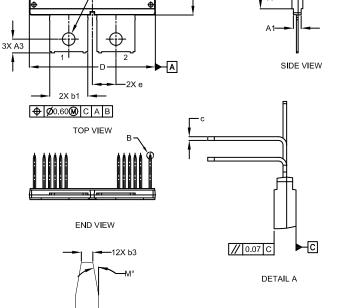


2X E1

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS D & E DO NOT INCLUDE MOLD PROTRUSIONS
- 4. DIMENSIONS b,b1,b2 DO NOT INCLUDE DAMBAR REMAIN.
- 5. MARKING AREA.





♦ Ø0.60**M** C A B

	MILLIMETERS			
DIM	MIN.	NOM.	MAX.	
Α	4.60	4.80	5.00	
A1	3.20	3.40	3.60	
A2	1.70	2.05	2.40	
А3	5.70	6.00	6.30	
b	15.20	15.30	15.40	
b1	16.50	16.60	16.70	
b2	0.90	1.00	1.10	
b3	0.50 REF			
С	0.70	0.80	0.90	
D	54.80	55.00	55.20	
D1	50.70	51.00	51.30	
E	54.80	55.00	55.20	

	MILLIMETERS			
DIM	MIN.	NOM.	MAX.	
E1	49.40	49.60	49.80	
E2	40.70	41.00	41.30	
е	10.00	10.30	10.60	
e1	11.15	11.45	11.75	
e2	2.40 BSC			
e3	4.20 BSC			
F	5.40	5.50	5.60	
L	14.17	14.47	14.77	
L1	16.20	16.50	16.80	
L2	3.20	3.50	3.80	
L3	7.70	8.00	8.30	
М	10° REF			

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DESCRIPTION:	AHPM15-CDE AUTOMOTIVE MODULE		PAGE 1 OF 2

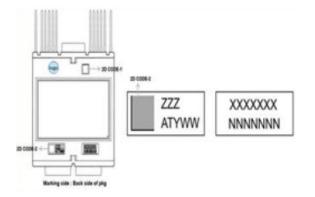
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DETAIL B

AHPM15-CDE AUTOMOTIVE MODULE

CASE MODHT ISSUE O

GENERIC MARKING DIAGRAM* **DATE 23 APR 2021**



ZZZ = Assembly Lot Code

ΑT = Assembly & Test Location

= Year

WW = Work Week

XXXX = Specific Device Code

NNNN = Serial Number

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	AHPM15-CDE AUTOMOTIVE MODULE		PAGE 2 OF 2

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